

N-Channel Super Junction Power MOSFET $\ensuremath{\,\mathrm{IV}}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- Optimized body diode reverse recovery performance
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

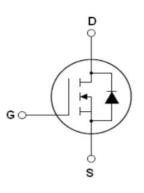
Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

Package Marking And Ordering Information

Device	Device Package	Marking	
NCE70N1K4F	TO-220F-3L	NCE70N1K4F	

V_{DS min@Tjmax} 750 V R_{DS(ON)TYP}. 1200 mΩ I_D 3.5 A Qg 5 nC



Schematic diagram



TO-220F

Table 1. Absolute Maximum Ratings (T_c=25℃) Parameter Symbol Value Unit Drain-Source Voltage (VGS=0V) VDS 700 V Vgs ± 30 V Gate-Source Voltage (VDS=0V), AC (f>1 Hz) Gate-Source Voltage (VDS=0V) ,DC Vgs ± 20 V Continuous Drain Current at Tc=25°C 3.5 А D (DC) Continuous Drain Current at Tc=100°C 2.45 А D (DC) Pulsed drain current (Note 1) 10.5 А DM (pluse) Maximum Power Dissipation(Tc=25°C) W PD 29.6 Derate above 25°C 0.20 W/°C Single pulse avalanche current (Note 2) 1 А IAS Reverse diode dv/dt, $V_{DS} \leq 480 V, I_{SD} < I_D$ dv/dt 15 V/ns dv/dt V/ns Drain Source voltage slope, $V_{DS} \leq 480 \text{ V}$ 50 Operating Junction and Storage Temperature Range °C T_J, T_{STG} -55...+175



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	5.07	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states					· ·	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250uA	700			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125°C)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			50	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V			±200	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250$ uA	3		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1.7A		1200	1400	mΩ
Dynamic Characteristics						
Gate Resistance	Rg	F=1MHZ, D-S short		36		Ω
Input Capacitance	Clss			281		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,		17		pF
Reverse Transfer Capacitance	C _{rss}	F=1MHz		4		pF
Total Gate Charge	Qg			5		nC
Gate-Source Charge	Q _{gs}	V_{DS} =500V,I _D =1.7A,		0.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		0.9		nC
Gate plateau voltage	Vgp			4.8		V
Switching times						
Turn-on Delay Time	t _{d(on)}			9		nS
Turn-on Rise Time	tr	V_{DD} =500V, I_{D} =1.7A,		6		nS
Turn-Off Delay Time	t _{d(off)}	$R_G=4\Omega, V_{GS}=10V$		50		nS
Turn-Off Fall Time	t _f			9		nS
Source- Drain Diode Characteristics	•					
Source-drain current(Body Diode)	I _{SD}	T05°O			3.5	А
Pulsed-Source-drain current(Body Diode)	I _{SDM}	T _c =25°C			10.5	А
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =3.5A,V _{GS} =0V		0.9	1.1	V
Reverse Recovery Time	t _{rr}			190		nS
Reverse Recovery Charge	Q _{rr}	Tj=25°C,I⊧1.7A,		0.57		uC
Peak reverse recovery current	I _{rrm}	di/dt=100A/µs		6		А

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

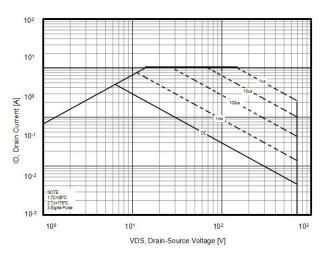


Figure3. Output characteristics

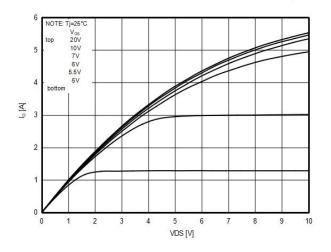


Figure5. Static drain-source on resistance

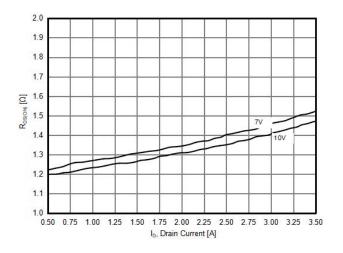


Figure2. Source-Drain Diode Forward Voltage

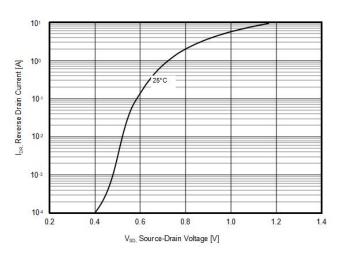


Figure4. Transfer characteristics

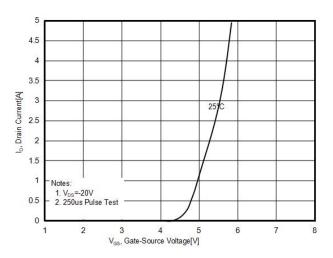


Figure6. RDS(ON) vs Junction Temperature

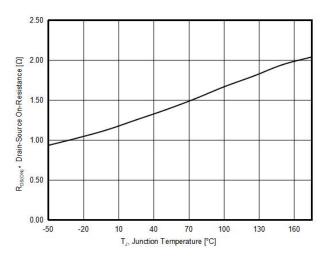




Figure 7. BV_{DSS} vs Junction Temperature

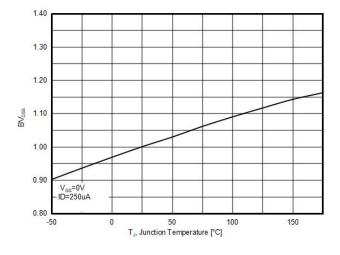


Figure9. Gate charge waveforms

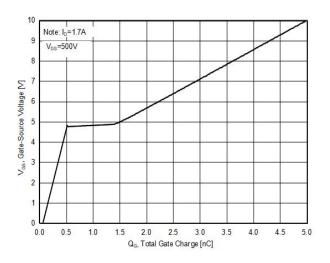
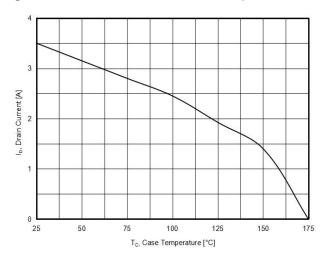
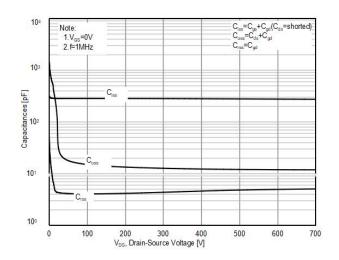


Figure8. Maximum I_D vs Junction Temperature



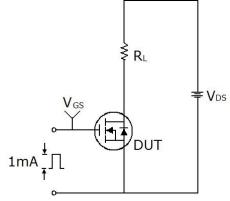


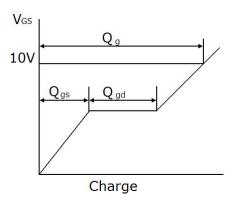




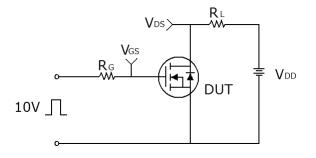
Test circuit

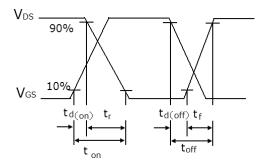
1) Gate charge test circuit & Waveform



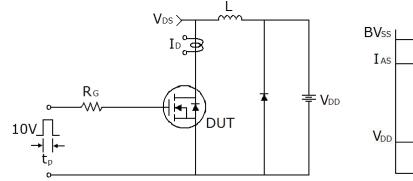


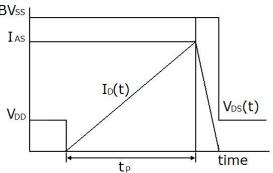
2) Switch Time Test Circuit:





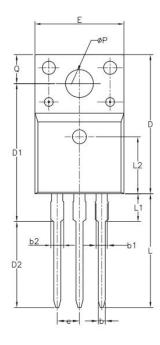
3) Unclamped Inductive Switching Test Circuit & Waveforms

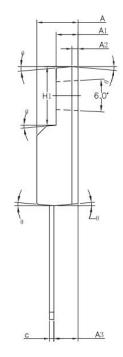






TO-220F-P Package Information





Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	4.50	4.83	0.177	0.190	
A1	2.34	2.74	0.092	0.108	
A2	0.70 REF		0.028 REF		
A3	2.56	2.93	0.101 0.11		
b	0.70	0.90	0.028	0.035	
b1	1.18	1.38	0.046	0.054	
b2		1.47		0.058	
с	0.45	0.60	0.018	0.024	
D	15.67	16.07	0.616	0.631	
D1	15.55	15.95	0.611	0.627	
D2	9.60	10.00	0.377	0.393	
E	9.96	10.36	0.391	0.407	
e	2.54 BSC		0.100 BSC		
H1	6.48	6.88	0.255	0.270	
L	12.68	13.28	0.498	0.522	
L1		3.50		0.138	
L2	6.50 REF		0.255 REF		
Ø P	3.08	3.28	0.121	0.129	
Q	3.20	3.40	0.126	0.134	
θ1	1.0°	5.0°	1.00°	5.00°	



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